

General Description

The MAX6691 four-channel thermistor temperature-topulse-width converter measures the temperatures of up to four thermistors and converts them to a series of output pulses whose widths are related to the thermistors' temperatures. Each of the four thermistors and an external fixed resistor (REXT) form a voltage-divider that is driven by the MAX6691's internal voltage reference (VRFF). VRFF and the voltage across RFXT are measured and converted to a pulse.

The MAX6691 has a single open-drain I/O pin that can be readily connected to a variety of microcontrollers. The microcontroller initiates a conversion by pulling the I/O pin low and releasing it. When conversion is done, the MAX6691 signals the end of conversion by pulling the I/O pin low once again. The pulse corresponding to the first thermistor is sent immediately after the release of the I/O pin.

The on-chip power-management circuitry reduces the average thermistor current to minimize errors due to thermistor self-heating. Between conversions, the MAX6691 falls into a 10µA (max) sleep mode, where the voltage reference is disabled and the supply current is at its minimum.

The MAX6691 is available in a 10-pin µMAX package and is specified from -55°C to +125°C temperature range.

Applications

HVAC Home Appliances **Medical Devices**

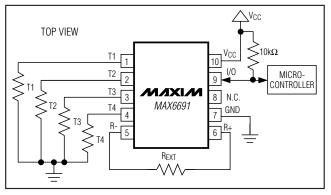
Features

- **♦ Simple Single-Wire Interface**
- **♦** Measures Up to Four Thermistor Temperatures
- **♦ Low-Average Thermistor Current Minimizes Self-Heating Errors**
- ♦ Internal Voltage Reference Isolates Thermistor from Power-Supply Noise
- **♦** Accommodates Any Thermistor Temperature Range

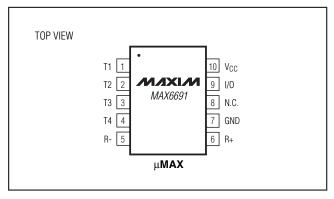
Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	PKG CODE
MAX6691MUB	-55°C to +125°C	10 μMAX	U10-2

Typical Application Circuit



Pin Configuration



/VIXI/VI

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

V _{CC} to GND	0.3V to +6.0V
All Other Pins to GND	$0.3V \text{ to } (V_{CC} + 0.3V)$
I/O, R+, R-, T1-T4 Current	±20mÁ
ESD Protection (Human Body Model)	±2000V
Continuous Power Dissipation ($T_A = +70$ °C	
10-Pin uMAX (derate 5.6mW/°C above +	70°C) 444 4mW

Operating Temperature Range	55°C to +125°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = 3.0V to 5.5V, T_A = -55°C to +125°C, unless otherwise noted. Typical values are specified at V_{CC} = 3.3V and T_A = +25°C.) (Note1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
THIGH/TLOW Accuracy	Vasva	$T_A = +25^{\circ}C$, $V_{CC} = 3.3V$			0.5	% FS
	V _{REXT}	$T_A = T_{MIN}$ to T_{MAX}			1.0	
Supply Voltage Range	Vcc		3.0		5.5	V
Supply Current	Icc	During conversion, no load		300	600	μΑ
Sleep-Mode Supply Current	ISTANDBY			3.5	10	μΑ
Input Leakage Current	ILEAKAGE				1.0	μΑ
Reference Voltage Output	V _{REF}	$I_{REF} = 1 \text{mA}, T_A = +25 ^{\circ}\text{C}$	1.19	1.24	1.32	V
Reference Load Regulation		0 < I _{REF} < 2mA		0.1	0.2	%
Reference Supply Rejection				0.2		%
Logic Input Low Voltage	VIL				0.3 × V _{CC}	V
Logic Input High Voltage	V _{IH}		0.7 × VCC			V

TIMING CHARACTERISTICS

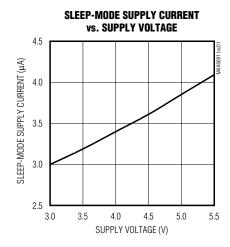
 $(V_{CC} = 3.0V \text{ to } 5.5V, T_A = -55^{\circ}\text{C to } +125^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are specified at $V_{CC} = 3.3V$ and $T_A = +25^{\circ}\text{C}.)$ (Figure 1) (Note1)

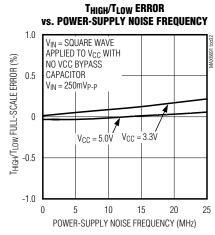
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Glitch Immunity on I/O Input				500		ns
Conversion Time	tCONV		86	102	156	ms
Nominal Pulse Width	tLOW		4.0	4.9	7.5	ms
Start Pulse Width	tstart		5			μs
Data Ready Pulse Width	tREADY		103	122	188	μs
Error Pulse Width	terror		103	122	188	μs
Rise Time	trise	$C_L = 15pF, R_L = 10k\Omega$		600	•	ns
Fall Time	tFALL	$C_L = 15pF, R_L = 10k\Omega$		600		ns

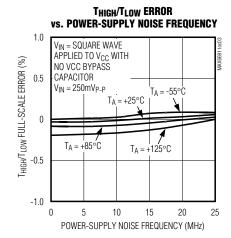
Note 1: Specification limits over temperature are guaranteed by design, not production tested.

Typical Operating Characteristics

(V_{CC} = 5V, R_{EXT} = 7.5k Ω , R_{TH} = 12.5k Ω , T_A = +25°C, unless otherwise noted.)







Pin Description

PIN	NAME	FUNCTION	
1	T1	Thermistor 1. Connect to external thermistor 1.	
2	T2	Thermistor 2. Connect to external thermistor 2.	
3	T3	Thermistor 3. Connect to external thermistor 3.	
4	T4	Thermistor 4. Connect to external thermistor 4.	
5	R-	External Resistor Low Side. Connect R _{EXT} between R- and R+.	
6	R+	Reference Voltage Output. Connect R _{EXT} between R- and R+.	
7	GND	Ground. Ground connection for MAX6691 and ground return for external thermistor(s).	
8	N.C.	No Connection. Do not make a connection to this pin.	
9	I/O	I/O Connection to Microcontroller. Connect a 10kΩ pullup resistor from I/O pin to V _{CC} .	
10	V _C C	Supply Voltage. Bypass V _{CC} to GND with a capacitor of at least 0.1µF.	

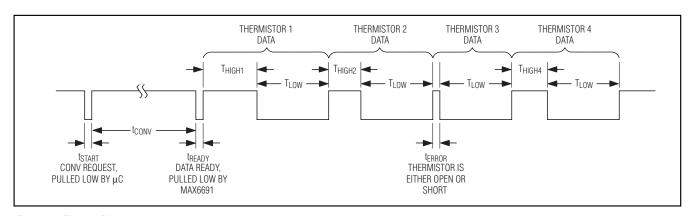


Figure 1. Timing Diagram

Detailed Description

The MAX6691 is an interface circuit that energizes up to four thermistors and converts their temperatures to a series of output pulses. The MAX6691 powers the thermistors only when a measurement is being made. This minimizes the power dissipation in the thermistors, virtually eliminating self-heating, a major component of thermistor error. The simple I/O allows the initiation of conversion and delivery of output pulses or a single pin.

Temperature Measurement

When it is not performing conversions or transmitting output pulses, the MAX6691 is in a low-power sleep mode and the I/O pin is held at VCC by the external pullup resistor (typically $10k\Omega$). To initiate measurement of up to four thermistor temperatures, the external microcontroller pulls the I/O pin low for at least 5µs (Figure 1). When the microcontroller releases the I/O pin, the MAX6691 applies the reference voltage (VREF) to the external resistor (REXT), which is connected sequentially to each of the four external thermistors (T1 through T4).

When the measurements are complete (after a period equal to T_{CONV}), the MAX6691 pulls the I/O pin low for 125µs. The I/O pin remains high for a period proportional to the first V_{EXT} measurement (corresponding to the first thermistor). The MAX6691 then pulls the I/O pin low for a period proportional to V_{REF} . Three more high/low pulse pairs follow, corresponding to T2 through T4, after which the I/O pin is released.

The relationship between pulse width, REXT, and thermistor resistance (RTH) can be described as:

$$\frac{T_{HIGH}}{T_{LOW}} = \frac{V_{EXT}}{V_{REF}} - 0.0002 = \frac{R_{EXT}}{R_{EXT} + R_{TH}} - 0.0002$$

The relationship between $V_{\rm EXT}$ and the temperature of a thermistor is determined by the values of $R_{\rm EXT}$ and the thermistor's characteristics. If the relationship between $R_{\rm TH}$ and the temperature is known, a microcontroller with no on-chip ADC can measure $T_{\rm HIGH}$ and $T_{\rm LOW}$ and accurately determine the temperature at the corresponding thermistor.

For each operation, the MAX6691 generates four pulses on the I/O pin. In the case of an open or short connection on the thermistor, the corresponding pulse (Thigh) is a short pulse of less than 5% of T_{LOW} .

_Applications Information

Thermistors and Thermistor Selection

Either NTC or PTC thermistors can be used with the MAX6691, but NTC thermistors are more commonly used. NTC thermistors are resistive temperature sensors whose resistance decreases with increasing temperature. They are available in a wide variety of packages that are useful in difficult applications such as measurement of air or liquid temperature. Some can operate over temperature ranges beyond that of most ICs. The relationship between temperature and resistance in an NTC thermistor is very nonlinear and can be described by the following approximation:

$$\frac{1}{T} = A + B(InR) + C(InR)^3$$

Where T is absolute temperature, R is the thermistor's resistance, and A, B, C are coefficients that vary with manufacturer and material characteristics. The general shape of the curve is shown in Figure 2.

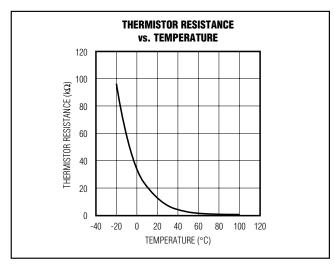


Figure 2. Thermistor Resistance vs. Temperature

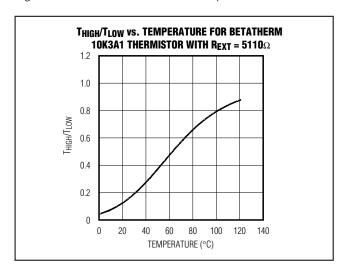


Figure 3. THIGH/TLOW vs. Temperature, $R_{EXT} = 5110\Omega$

The relationship between temperature and resistance of an NTC thermistor is highly nonlinear. However, by connecting the thermistors in series with a properly chosen resistor (REXT) and using the MAX6691 to measure the voltage across the resistor, a reasonably linear transfer function can be obtained over a limited temperature range. Linearity improves for smaller temperature ranges.

Figures 3 and 4 show typical THIGH/TLOW curves for a standard thermistor in conjunction with values of REXT chosen to optimize linearity over two series resistors chosen to optimize linearity over two different temperature ranges.

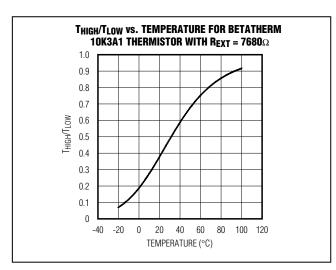


Figure 4. THIGH/TLOW vs. Temperature, $R_{EXT} = 7680\Omega$

NTC thermistors are often described by the resistance at +25°C. Therefore, a $10k\Omega$ thermistor has a resistance of $10k\Omega$ at +25°C. When choosing a thermistor, ensure that the thermistor's minimum resistance (which occurs at the maximum expected operating temperature) in series with REXT does not cause the voltage reference output current to exceed about 1mA. Some standard $10k\Omega$ thermistors with similar characteristics are listed in Table 1.

Choosing REXT

Choose REXT to minimize nonlinearity errors from the thermistor:

- Decide on the temperature range of interest (for example 0°C to +70°C).
- 2) Find the thermistor values at the limits of the temperature range. R_{MIN} is the minimum thermistor value (at the maximum temperature) and R_{MAX} is the maximum thermistor value (at the minimum temperature). Also find R_{MID} , the thermistor resistance in the middle of the temperature range (+35°C for the 0°C to +70°C range).
- 3) Find REXT using the equation below:

$$R_{EXT} \, = \, \frac{R_{MID} \big(R_{MIN} + R_{MAX} \big) - 2 R_{MIN} \times R_{MAX}}{R_{MIN} + R_{MAX} - 2 R_{MID}}$$

Power-Supply Considerations

The MAX6691 accuracy is relatively unaffected by power-supply coupled noise. In most applications,

Table 1. Standard Thermistors

MANUFACTURER	PART	WEBSITE
Betatherm	10K3A1	www.betatherm.com/indexna.htm
Dale	1M1002	www.vishay.com/brands/dale/main.html
Thermometrics	C100Y103J	www.thermometrics.com

bypass VCC to GND by placing a $0.1\mu F$ to $1.0\mu F$ ceramic bypass capacitor close to the supply pin of the devices.

Thermal Considerations

Self-heating degrades the temperature measurement accuracy of thermistors. The amount of self-heating depends on the power dissipated and the dissipation constant of the thermistor. Dissipation constants depend on the thermistor's package and can vary considerably.

A typical thermistor might have a dissipation constant equal to 1mW/°C. For every milliwatt the thermistor dissipates, its temperature rises by 1°C. For example, consider a 10k Ω (at +25°C) NTC thermistor in series with a 5110 Ω resistor operating +40°C with a constant 5V bias. If it is one of the standard thermistors previously mentioned, its resistance is 5325 Ω at this temperature. The power dissipated in the thermistor is:

 $(5V)^2(5325\Omega) / (5325\Omega + 5110\Omega)^2 = 1.22$ mW

This thermistor therefore has a self-heating error at +40°C of 1.22°C. Because the MAX6691 uses a small reference voltage and energizes each thermistor for only about 25ms per conversion cycle, the self-heating of the thermistor under the same conditions when used with the MAX6691 is far less. Assuming one conversion cycle every 5s, each thermistor is energized only 0.5% of the time:

 $(1.22)^2 (5325)(0.005) / (5325 + 5110)^2 = 0.364 \mu W$, or only about 0.00036°C self-heating error.

Chip Information

TRANSISTOR COUNT: 7621

PROCESS: BICMOS

Functional Diagram

